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TECHNICAL DATA SHEETS MP 5401

Description:

MP 5401 is a one component, heat curable thixotropic paste epoxy adhesive. It is a non-sag adhesive, which forms strong bonds to metals and ceramics. MP 5401 has exceptional thermal stability and resistance to water, humidity and solvents. This product offers high heat resistance and cures in less than 36 seconds via induction or infrared heating.

Typical Applications:

- Permanent Magnet Motors and Loudspeaker Assembly
- Air Conditioning Joint Tubes and Compressors
- High Temperature Structural Bonding
- Filter End Cap and Side Seam Assembly

Physical Properties:

Standard Color Specific Gravity Viscosity Press Flow Sag Resistance Tensile Strength Lap Shear Strength Hardness Elongation Impact Strength

CTE Tg

Operating Temperature Range Thermal Conductivity (BTU/HR/FT2/ F/FT) Unleaded Gasoline Resistance (1,500 Hrs.) Gray 1.41 @ 25 °C

700,000-900,000 cps @ 25 °C

70-90 seconds 0.375" - 0.420" 6,770 psi Typical 3,200 psi Typical 86 Shore D @ 25 °C >1.5%

>1.5% 0.36 ft lbs/in 5.72 x 10⁻⁵ in/in °C

5.72 x 10⁻³ in/in °C 148 C

-40 to 400 °F 235

3,200 psi Typical Prior to test

3,200 psi Typical After 1500 hours of submersion

Cure Schedule:

250 °F 300 °F 350 °F Induction @ 400 °F 10 min. 2 min. 1 min. <36 seconds

Engineering Excellence

For technical information and support call 1-800-552-0299 or visit our website at



Storage:

<32 °F 75 °F 100 °F 12 months 6 months 2 weeks</p>